

# 2.5V Drive Nch MOSFET

RSU002N06

●Structure

Silicon N-channel MOSFET

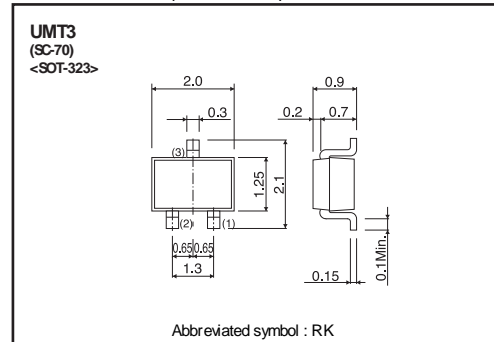
●Features

- 1) High speed switing.
- 2) Small package(UMT3).
- 3) Low voltage drive(2.5V drive).

●Application

Switching

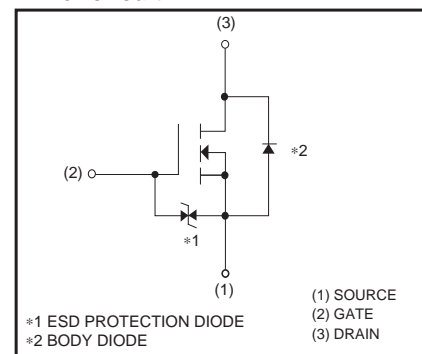
●Dimensions (Unit : mm)



●Packaging specifications

|           |                              |        |
|-----------|------------------------------|--------|
| Type      | Package                      | Taping |
|           | Code                         | T106   |
|           | Basic ordering unit (pieces) | 3000   |
| RSU002N06 |                              | ○      |

●Inner circuit



●Absolute maximum ratings (Ta = 25°C)

| Parameter                    | Symbol     | Limits        | Unit         |
|------------------------------|------------|---------------|--------------|
| Drain-source voltage         | $V_{DSS}$  | 60            | V            |
| Gate-source voltage          | $V_{GSS}$  | $\pm 20$      | V            |
| Drain current                | Continuous | $I_D$         | $\pm 250$ mA |
|                              | Pulsed     | $I_{DP}^{*1}$ | $\pm 1$ A    |
| Source current (Body Diode)  | Continuous | $I_S$         | 150 mA       |
|                              | Pulsed     | $I_{SP}^{*1}$ | 1 A          |
| Power dissipation            | $P_D^{*2}$ | 200           | mW           |
| Channel temperature          | $T_{ch}$   | 150           | °C           |
| Range of storage temperature | $T_{stg}$  | -55 to +150   | °C           |

\*1  $P_w \leq 10 \mu s$ , Duty cycle  $\leq 1\%$

\*2 Each terminal mounted on a recommended land.

●Thermal resistance

| Parameter          | Symbol           | Limits | Unit   |
|--------------------|------------------|--------|--------|
| Channel to ambient | $R_{th}(ch-a)^*$ | 625    | °C / W |

\* Each terminal mounted on a recommended land.

## ●Electrical characteristics (Ta = 25°C)

| Parameter                               | Symbol         | Min. | Typ. | Max. | Unit | Conditions                      |
|---|----------------|------|------|------|------|---------------------------------|
| Gate-source leakage                     | $I_{GSS}$      | -    | -    | ±10  | μA   | $V_{GS}=\pm 20V, V_{DS}=0V$     |
| Drain-source breakdown voltage          | $V_{(BR)DSS}$  | 60   | -    | -    | V    | $I_D=1mA, V_{GS}=0V$            |
| Zero gate voltage drain current         | $I_{DSS}$      | -    | -    | 1    | μA   | $V_{DS}=60V, V_{GS}=0V$         |
| Gate threshold voltage                  | $V_{GS(th)}$   | 1.0  | -    | 2.3  | V    | $V_{DS}=10V, I_D=1mA$           |
| Static drain-source on-state resistance | $R_{DS(on)}$ * | -    | 1.7  | 2.4  | Ω    | $I_D=250mA, V_{GS}=10V$         |
|   |                | -    | 2.1  | 3.0  |      | $I_D=250mA, V_{GS}=4.5V$        |
|   |                | -    | 2.3  | 3.2  |      | $I_D=250mA, V_{GS}=4.0V$        |
|   |                | -    | 3.0  | 12.0 |      | $I_D=10mA, V_{GS}=2.5V$         |
| Forward transfer admittance             | $ Y_{fs} $ *   | 0.25 | -    | -    | S    | $I_D=250mA, V_{DS}=10V$         |
| Input capacitance                       | $C_{iss}$      | -    | 15   | -    | pF   | $V_{DS}=25V$                    |
| Output capacitance                      | $C_{oss}$      | -    | 4.5  | -    | pF   | $V_{GS}=0V$                     |
| Reverse transfer capacitance            | $C_{rss}$      | -    | 2.0  | -    | pF   | $f=1MHz$                        |
| Turn-on delay time                      | $t_{d(on)}$ *  | -    | 3.5  | -    | ns   | $I_D=100mA, V_{DD} \approx 30V$ |
| Rise time                               | $t_r$ *        | -    | 5    | -    | ns   | $V_{GS}=10V$                    |
| Turn-off delay time                     | $t_{d(off)}$ * | -    | 18   | -    | ns   | $R_L \approx 300\Omega$         |
| Fall time                               | $t_f$ *        | -    | 28   | -    | ns   | $R_G=10\Omega$                  |

\*Pulsed

## ●Body diode characteristics (Source-Drain) (Ta = 25°C)

| Parameter       | Symbol     | Min. | Typ. | Max. | Unit | Conditions             |
|-----------------|------------|------|------|------|------|------------------------|
| Forward voltage | $V_{SD}$ * | -    | -    | 1.2  | V    | $I_S=250mA, V_{GS}=0V$ |

\*Pulsed

●Electrical characteristic curves

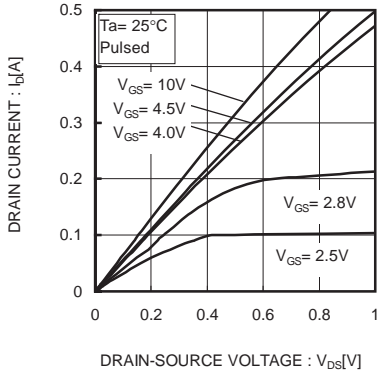


Fig.1 Typical Output Characteristics (I)

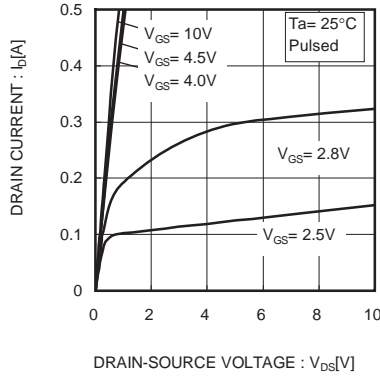


Fig.2 Typical Output Characteristics (II)

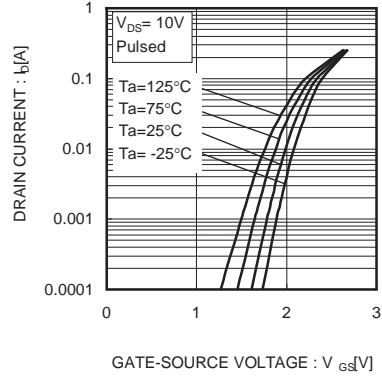


Fig.3 Typical Transfer Characteristics

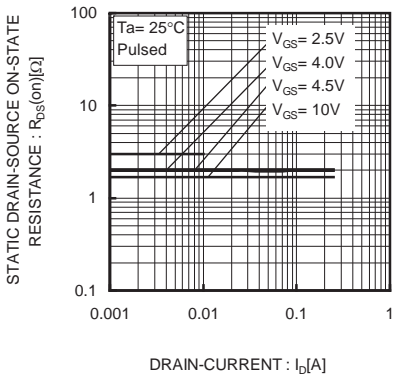


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

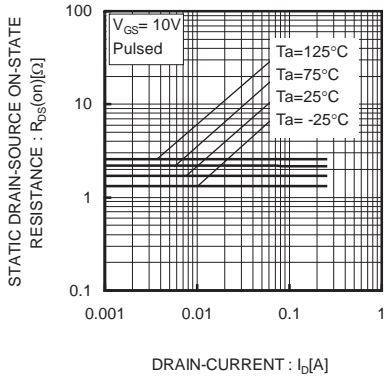


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

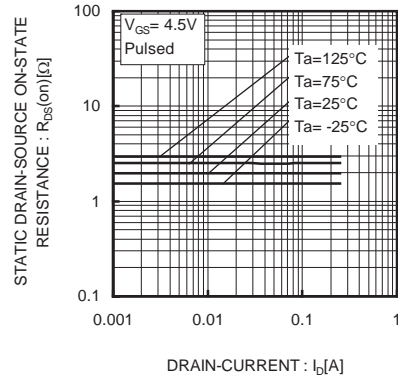


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (III)

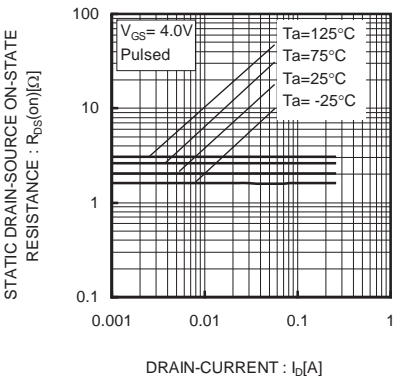


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (IV)

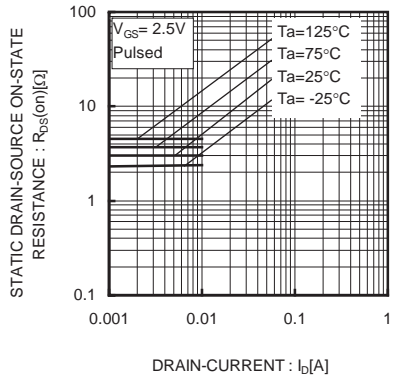


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (IV)

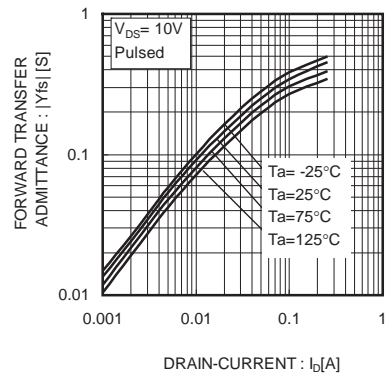


Fig.9 Forward Transfer Admittance vs. Drain Current

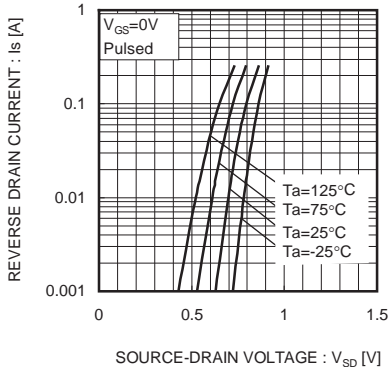


Fig.10 Reverse Drain Current vs. Source-Drain Voltage

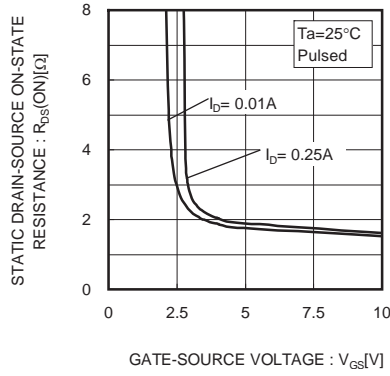


Fig.11 Static Drain-Source On-State Resistance vs. Gate Source Voltage

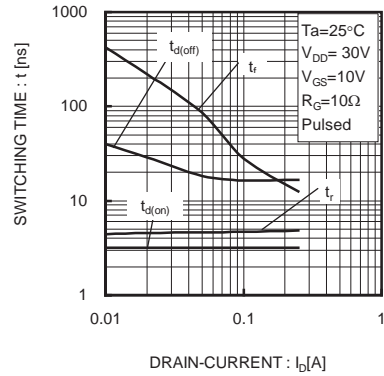


Fig.12 Switching Characteristics

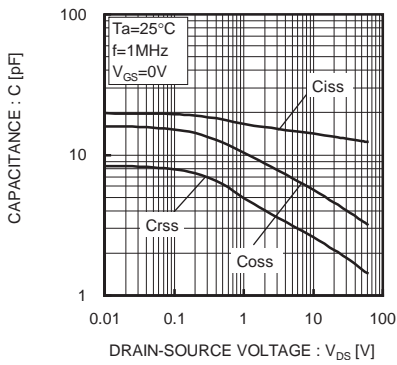


Fig.13 Typical Capacitance vs. Drain-Source Voltage

●Measurement circuits

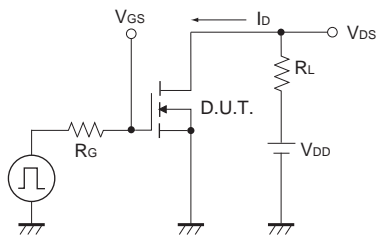


Fig.1-1 Switching time measurement circuit

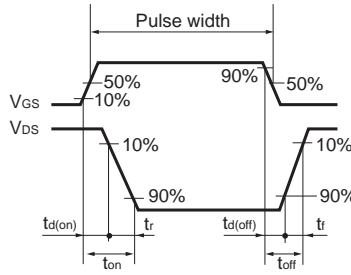


Fig.1-2 Switching waveforms

●Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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